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# 1.4 pC Charge Injection, 100 pA Leakage, Quad SPST Switches

#### **DESCRIPTION**

The DG611E, DG612E, and DG613E contain four independently selectable SPST switches. They offer improved performance over the industry standard DG611 and DG611A series. The DG611E and DG612E have all switches normally closed and normally open respectively, while the DG613E has 2 normally open and 2 normally closed switches.

They are designed to operate from a 3 V to 16 V single supply or from  $\pm$  3 V to  $\pm$  8 V dual supplies and are fully specified at +3 V, +5 V and  $\pm$  5 V. All control logic inputs have guaranteed 2 V logic high limits when operating from +5 V or  $\pm$  5 V supplies and 1.4 V when operating from a +3 V supply.

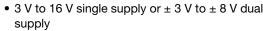
The DG611E, DG612E, and DG613E switches conduct equally well in both directions and offer rail to rail analog signal handling.

1.4 pC low charge injection, coupled with very low switch capacitance: 3 pF, fast switching speed:  $t_{on}/t_{off}$  23 ns/14 ns and excellent 3 dB bandwidth: 1 GHz, make these products ideal for precision instrumentation, high-end data acquisition, automated test equipment and high speed communication applications.

Operation temperature is specified from -40 °C to +125 °C.

The DG611E, DG612E, and DG613E are available in 16 lead SOIC, TSSOP and the space saving 1.8 mm x 2.6 mm miniQFN packages.

#### **FEATURES**





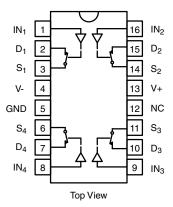
- Leakage current < 0.25 nA at 85 °C</li>
- Low switch capacitance (C<sub>soff</sub> 3 pF typ.)
- Fully specified with single supply operation at 3 V, 5 V, and dual supplies at ± 5 V
- Low voltage, 2.5 V CMOS/TTL compatible
- 1 GHz, 3 dB bandwidth
- Excellent isolation performance (-59 dB at 10 MHz)
- Excellent crosstalk performance (-74 dB at 10 MHz)
- Fully specified from -40 °C to +85 °C and -40 °C to +125 °C
- 16 lead SOIC, TSSOP and miniQFN package (1.8 mm x 2.6 mm)
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

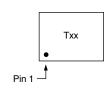
#### **APPLICATIONS**

- · Precision instrumentation
- Medical instrumentation
- Automated test equipment
- · High speed communications applications
- High-end data acquisition
- Sample and hold applications
- · Sample and hold systems

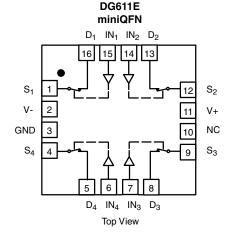
#### **FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION**







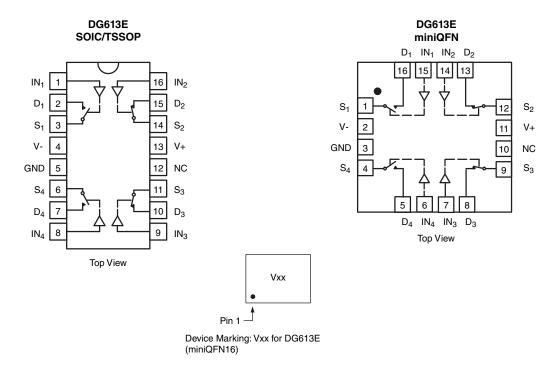
Device Marking: Txx for DG611E (miniQFN16) Uxx for DG612E Vxx for DG613E xx = Date/Lot Traceability Code



TRUTH TABLE							
LOGIC	DG611E	DG612E					
0	On	Off					
1	Off	On					

S20-0209-Rev. C, 20-Apr-2020 **1** Document Number: 78910

#### **FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION**



TRUTH TABLE							
LOGIC	SW1, SW4	SW2, SW3					
0	Off	On					
1	On	Off					

ORDERING INFORMATION						
TEMP. RANGE	PACKAGE	PART NUMBER				
		DG611EEQ-T1-GE4				
	16-pin TSSOP	DG612EEQ-T1-GE4				
		DG613EEQ-T1-GE4				
		DG611EEY-T1-GE4				
-40 °C to +125 °C <sup>a</sup>	16-pin narrow SOIC	DG612EEY-T1-GE4				
		DG613EEY-T1-GE4				
		DG611EEN-T1-GE4				
	16-pin miniQFN	DG612EEN-T1-GE4				
		DG613EEN-T1-GE4				

#### Note

a. -40 °C to +85 °C datasheet limits apply



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ABSOLUTE MAXIMUM RATI	NGS (T <sub>A</sub> = 25 °C, unless other	wise noted)		
PARAMETER		LIMIT	UNIT	
V+ to V-		-0.3 to +18		
GND to V-		18		
$V_S, V_D$	(V-) - 0.3 to (V+) + 0.3 or 30 mA, whichever occurs first	V		
Digital inputs <sup>a</sup>		(GND) - 0.3 to 18		
Continuous current (any terminal)		30	mA	
Peak current, S or D (pulsed 1 ms, 10 %	duty cycle)	100		
Storage temperature		-65 to +150		
	16-pin TSSOP <sup>c</sup>	450		
Power dissipation (package) <sup>b</sup>	16-pin miniQFN <sup>d</sup>	525	mW	
	16-pin narrow SOIC <sup>e</sup>	640		
	16-pin TSSOP	178		
Thermal resistance (package) b	16-pin miniQFN	152	°C/W	
	16-pin narrow SOIC	125		
ESD / HBM	EIA / JESD22-A114-A	2K	V	
ESD / CDM	EIA / JESD22-C101-A	1K	V	
Latch up	JESD78	300	mA	

#### **Notes**

- a. Signals on SX, DX, or INX exceeding V+ or V- will be clamped by internal diodes. Limit forward diode current to maximum current ratings
- b. All leads welded or soldered to PC board
- c. Derate 5.6 mW/°C above 70 °C
- d. Derate 6.6 mW/°C above 70 °C
- e. Derate 8 mW/°C above 70 °C
- f. Manual soldering with iron is not recommended for leadless components. The miniQFN-16 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper lip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection



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		TEST CONDITIONS								
PARAMETER	SYMBOL	UNLESS OTHERWISE SPECIFIED	TEMP. b		-40 °C to	o +125 °C	-40 °C t	o +85 °C	UNIT	
TATAMETER	OTTO	V + = +5 V, V - = -5 V $V_{IN} = 2 V, 0.8 V^a$	12	TYP. c	MIN. d	MAX. d	MIN. d		1	
Analog Switch		V <sub>IN</sub> – 2 V, 0.3 V			IVIII V.	1117-04.	101114.	IVI/JX.		
Analog signal range <sup>e</sup>	V		Full	l _	- 5	5	- 5	5	Ιv	
0 0 0	V <sub>ANALOG</sub>			72	- 5	115	- 5	115	V	
Drain-source on-resistance	R <sub>DS(on)</sub>	$I_S = 1 \text{ mA}, V_D = -3 \text{ V}, 0 \text{ V}, +3 \text{ V}$	Room Full	12	-		_	140		
on resistance				-	-	160	-		-	
On-resistance match	$\Delta R_{DS(on)}$	$I_S = 1 \text{ mA}, V_D = \pm 3 \text{ V}$	Room Full	0.6	-	2.5 5	-	2.5 4.5	Ω	
			Room	15	-	20	_	20	1	
On-resistance flatness	R <sub>flat(on)</sub>	$I_S = 1 \text{ mA}, V_D = -3 \text{ V}, 0 \text{ V}, +3 \text{ V}$	Full	-	-	30	-	25	1	
	I <sub>S(off)</sub>	V. FEVV FEV	Room	± 0.0005	-0.1	0.1	-0.1	0.1		
Switch off	0(011)	$V_{+} = 5.5 \text{ V}, V_{-} = -5.5 \text{ V}$ $V_{D} = +4.5 \text{ V} / -4.5 \text{ V}$	Full	-	-2	2	-0.25	0.25	ĺ	
leakage current		$V_{S} = -4.5 \text{ V} / +4.5 \text{ V}$	Room	±0.006	-0.1	0.1	-0.1	0.1	nA	
	I <sub>D(off)</sub>		Full	-	-2	2	-0.25	0.25	1	
Switch on		V+ = 5.5 V, V- = -5.5 V	Room	±0.008	-0.1	0.1	-0.1	0.1	1	
leakage current	I <sub>D(on)</sub>	$V_D = V_S = \pm 4.5 \text{ V}$	Full	-	-6	6	-0.25	0.25	1	
Digital Control							l	<u>l</u>		
Input current, V <sub>IN</sub> low	I <sub>IL</sub>	V <sub>IN</sub> under test = 0.8 V	Full	0.01	-0.1	0.1	-0.1	0.1	Ι.	
Input current, V <sub>IN</sub> high	I <sub>IH</sub>	V <sub>IN</sub> under test = 2 V	Full	0.01	-0.1	0.1	-0.1	0.1	μA	
Input capacitance e	C <sub>IN</sub>	f = 1 MHz		3	-	-	-	-	pF	
Dynamic Characterist										
-			Room	23	_	50	_	50	ns	
Turn-on time	t <sub>ON</sub>	$R_L = 300 \Omega, C_L = 35 pF$ $V_S = \pm 3 V$	Full	-	-	75	-	60		
			Room	14	-	35	-	35		
Turn-off time	t <sub>OFF</sub>		Full	-	-	50	-	45		
Break-before-make		DG613E only, $V_S = 3 \text{ V}$	Room	15	-	-	-	-	1	
time delay	t <sub>BBM</sub>	$R_L = 300 \Omega$ , $C_L = 35 pF$	Full	-	2	-	2	-	-	
Charge injection e	Q <sub>INJ</sub>	$V_{g} = 0 \text{ V}, R_{g} = 0 \Omega, C_{L} = 1 \text{ nF}$	Room	1.4	-	-	-	-	рС	
Off isolation e	OIRR		Room	-59	-	-	-	-	<u> </u>	
Channel-to-channel crosstalk e	X <sub>TALK</sub>	$R_L = 50 \Omega$ , $C_L = 5 pF$ f = 10 MHz	Room	-74	-	-	-	-	dB	
Bandwidth <sup>e</sup>	BW	$R_L = 50 \Omega$ , $C_L = 5 pF$	Room	1	-	-	-	-	GHz	
Source off capacitance e	C <sub>S(off)</sub>		Room	3	-	-	-	-		
Drain off capacitance <sup>e</sup>	C <sub>D(off)</sub>	f = 1 MHz; V <sub>S</sub> = 0 V	Room	3	-	-	-	-	рF	
Drain on capacitance <sup>e</sup>	C <sub>D(on)</sub>	f = 1 MHz; V <sub>S</sub> = V <sub>D</sub> = 0 V	Room	7	-	-	-	-	-	
Total harmonic distortion <sup>e</sup>	THD	Signal = 1 $V_{RMS}$ , 20 Hz to 20 kHz, $R_L = 600 \Omega$	Room	0.13	=	-	-	-	%	
Power Supplies										
Dawar augusti a a a a a	1.		Room	0.001	-	0.1	-	0.1		
Power supply current	l+		Full	-	-	1	-	1		
Negative supply		V+ = +5 V, V- = -5 V	Room	-0.001	-0.1	-	-0.1	-	1	
current	I-	$V_{IN} = 0 \text{ V or } 5 \text{ V}$	Full	-	-1	-	-1	-	μA	
0				-0.001	-0.1	-	-0.1	-		
Ground current	$I_{GND}$		Full		-1	-	-1		1	



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		TEST CONDITIONS		LIMITS					
PARAMETER	SYMBOL	UNLESS OTHERWISE SPECIFIED	TEMP.b		-40 °C to	o +125 °C	-40 °C t	o +85 °C	UNI
		V+ = +5 V, V- = 0 V $V_{IN} = 2 V, 0.8 V a$		TYP.C	MIN. d	MAX. d	MIN. d	MAX. d	
Analog Switch	T			•		,	1	T	
Analog signal range e	V <sub>ANALOG</sub>		Full	-	0	5	0	5	V
Drain-source	R <sub>DS(on)</sub>	V+ = 5 V, V- = 0 V	Room	130	-	170	-	170	
on-resistance	1 103(011)	$I_S = 1 \text{ mA}, V_D = +3.5 \text{ V}$	Full	-	-	235	-	215	
On-resistance match	$\Delta R_{DS(on)}$	V+ = 5 V, V- = 0 V,	Room	0.6	-	5	-	5	Ω
	DO(OH)	$I_S = 1 \text{ mA}, V_D = 3.5 \text{ V}$	Full	-	-	12	-	10	
On-resistance flatness	R <sub>flat(on)</sub>	V+ = 5 V, V- = 0 V,	Room	29	-	50	-	50	
	· ·liat(OII)	$I_S = 1 \text{ mA}, V_D = 0 \text{ V}, 3.5 \text{ V}$	Full	-	-	100	-	90	
	I <sub>S(off)</sub>	V+ = 5.5 V, V- = 0 V	Room	± 0.0005	-0.1	0.1	-0.1	0.1	
Switch off leakage current		$V_D = 4.5 \text{ V} / 1 \text{ V}$	Full	-	-2	2	-0.25	0.25	
.ca.tago carront	I <sub>D(off)</sub>	$V_{S} = 1 \text{ V} / 4.5 \text{ V}$	Room	±0.006	-0.1	0.1	-0.1	0.1	nA
	-D(OII)		Full	-	-2	2	-0.25	0.25	
Switch on	I <sub>D(on)</sub>	V+ = 5.5 V, V- = 0 V	Room	±0.008	-0.1	0.1	-0.1	0.1	
leakage current	-D(011)	$V_D = V_S = 1 \text{ V} / 4.5 \text{ V}$	Full	-	-6	6	-0.25	0.25	
Digital Control	T			1		1	1	ı	
Input current, V <sub>IN</sub> low	I <sub>IL</sub>	V <sub>IN</sub> under test = 0.8 V	Full	0.01	-0.1	0.1	-0.1	0.1	μA
Input current, V <sub>IN</sub> high	I <sub>IH</sub>	V <sub>IN</sub> under test = 2 V	Full	0.01	-0.1	0.1	-0.1	0.1	, i
Input capacitance e	C <sub>IN</sub>	f = 1 MHz	Room	4	-	-	<u> </u>	-	pF
Dynamic Characterist	ics					1		ı	
Turn-on time e	t <sub>ON</sub>	$R_L = 300 \ \Omega, \ C_L = 35 \ pF$ $V_S = 3 \ V$	Room	33	-	60	-	60	ns
			Full	-	-	90	-	80	
Turn-off time e			Room	14	-	35	-	35	
	-011		Full	-	-	45	-	40	
Break-before-make	t <sub>BBM</sub>	DG613E only, $V_S = 3 \text{ V}$	Room	19	-	-	-	-	
time delay e	*DDIVI	$R_L = 300 \Omega, C_L = 35 pF$	Full	-	2	-	2	-	
Charge injection e	Q <sub>INJ</sub>	$V_g = 0 \text{ V}, R_g = 0 \Omega, C_L = 1 \text{ nF}$	Full	1.5	-	-	-	-	рC
Off isolation e	OIRR	$R_L = 50 \Omega, C_L = 5 pF$	Room	-59	-	-	-	-	
Channel-to-channel crosstalk <sup>e</sup>	X <sub>TALK</sub>	f = 10 MHz	Room	-70	-	-	-	-	dB
Bandwidth <sup>e</sup>	BW	$R_L = 50 \Omega$ , $C_L = 5 pF$	Room	880	-	-	-	-	MHz
Source off capacitance e	C <sub>S(off)</sub>	f = 1 MHz; V <sub>S</sub> = 0 V	Room	3	-	-	-	-	_
Drain off capacitance e	C <sub>D(off)</sub>		Room	3	-	=.	-	-	pF
Drain on capacitance e	C <sub>D(on)</sub>	$f = 1 \text{ MHz}; V_S = V_D = 0 \text{ V}$	Room	7	-		-	-	
Power Supplies									
Power supply current	l+		Room	0.001	-	0.1	-	0.1	
	IT.		Full	-	ı	1	-	1	- μΑ
Negative supply	I-	V <sub>IN</sub> = 0 V or 5 V	Room	-0.001	-0.1	-	-0.1	-	
current	I-	V <sub>IN</sub> = 0 v or 5 v	Full	_	-1		-1	-	
Ground current	lo::=		Room	-0.001	-0.1	-	-0.1	-	
Ground current	$I_{GND}$		Full	-	-1	-	-1	_	



		TEST CONDITIONS	TEMP. b	LIMITS					
PARAMETER	SYMBOL	UNLESS OTHERWISE SPECIFIED V + = +3 V, V - = - 0 V			-40 °C to +125 °C		-40 °C to +85 °C		UNIT
		V + = +3  V, V - = -0  V $V_{IN} = 1.4 \text{ V}, 0.6 \text{ V}^{a}$		TYP. c	MIN. d	MAX. d	MIN. d	MAX. d	
Analog Switch									
Analog signal range e	V <sub>ANALOG</sub>		Full	-	0	3	0	3	V
Drain source On-resistance	R <sub>DS(on)</sub>	I <sub>S</sub> = 1 mA, V <sub>D</sub> = +1.5 V	Room Full	305	-	420 600	-	420 500	Ω
				±	-0.1	0.1	-0.1	0.1	
Switch off	I <sub>S(off)</sub>	V+ = 3.3 V, V- = 0 V V <sub>D</sub> = 3 V / 0.3 V	Room Full	0.0005	-2	2	-0.25	0.25	-
leakage current		$V_{\rm D} = 3 \text{ V} / 0.3 \text{ V}$ $V_{\rm S} = 0.3 \text{ V} / 3 \text{ V}$	Room	±0.006	-0.1	0.1	-0.1	0.1	nA
	I <sub>D(off)</sub>	S	Full	-	-2	2	-0.25	0.25	IIA
Switch on		V+ = 3.3 V, V- = 0 V	Room	±0.008	-0.1	0.1	-0.1	0.1	1
leakage current	I <sub>D(on)</sub>	$V_D = V_S = 0.3 \text{ V} / 3 \text{ V}$	Full	-	-6	6	-0.25	0.25	
Digital Control			L			L	L		
Input current, V <sub>IN</sub> low	I <sub>IL</sub>	V <sub>IN</sub> under test = 0.6 V	Full	0.01	-0.1	0.1	-0.1	0.1	
Input current, V <sub>IN</sub> high	I <sub>IH</sub>	V <sub>IN</sub> under test = 1.4 V	Full	0.01	-0.1	0.1	-0.1	0.1	μA
Input capacitance e	C <sub>IN</sub>	f = 1 MHz	Room	4	-	-	-	-	pF
<b>Dynamic Characterist</b>	ics								
Turn-on time	t <sub>ON</sub>	$R_L = 300 \Omega, C_L = 35 pF$ $V_S = 2 V$	Room	76	-	115	-	115	- ns
rum on time			Full	-	-	180	-	155	
Turn-off time	t <sub>OFF</sub>		Room	31	-	58	-	58	
Turn on time	OFF		Full	-	-	65	-	60	110
Break-before-make	t <sub>BBM</sub>	DG613 only, $V_S = 2 V$	Room	60	-	-	-	-	
time delay	PDIVI	$R_L = 300 \Omega, C_L = 35 pF$	Full	-	10	-	10	-	
Charge injection e	Q <sub>INJ</sub>	$V_g = 0 \text{ V}, R_g = 0 \Omega, C_L = 1 \text{ nF}$	Room	1.4	-	-	-	-	рC
Off isolation e	OIRR	$R_L = 50 \Omega$ , $C_L = 5 pF$	Room	-59	-	-	-	-	
Channel-to-channel crosstalk <sup>e</sup>	X <sub>TALK</sub>	f = 10 MHz	Room	-71	-	-	-	-	dB
Bandwidth <sup>e</sup>	BW	$R_L = 50 \Omega$ , $C_L = 5 pF$	Room	830	-	-	-	-	MHz
Source off capacitance e	C <sub>S(off)</sub>	f = 1 MHz; V <sub>S</sub> = 0 V	Room	3	-	-	-	-	
Drain off capacitance e	$C_{D(off)}$	, 6	Room	4	-	-	-	-	pF
Drain on capacitance e	C <sub>D(on)</sub>	$f = 1 \text{ MHz}; V_S = V_D = 0 \text{ V}$	Room	7	-	-	-	-	
Power Supplies									
Power supply current	l+		Room Full	0.001	-	0.1	-	0.1	
Negative events			Room	-0.001	-0.1	-	-0.1	-	
Negative supply current	l-	$V_{IN} = 0 \text{ V or } 3 \text{ V}$	Full	-0.001	-0.1	_	-0.1	_	μA
			Room	-0.001	-0.1	-	-0.1	_	
Ground current	I <sub>GND</sub>		Full	0.001	-0.1	-	-0.1	-	

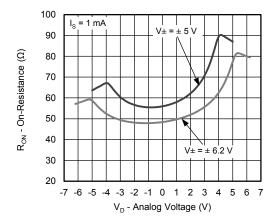
#### Notes

- a.  $V_{IN}$  = input voltage to perform proper function
- b. Room = 25 °C, Full = as determined by the operating temperature suffix
- c. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing
- d. The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this datasheet
- e. Guaranteed by design, not subject to production test

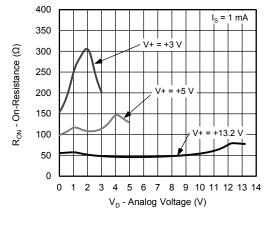
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



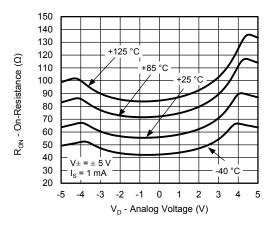
# TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



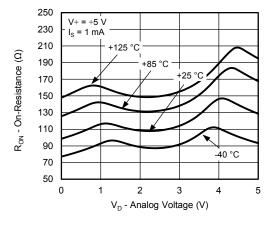
On-Resistance vs. V<sub>D</sub> (Dual Supply)



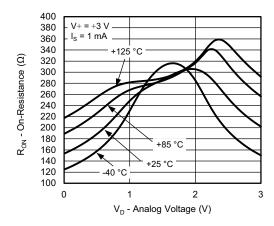
On-Resistance vs. V<sub>D</sub> (Single Supply)



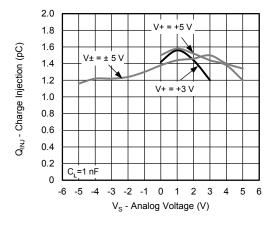
On-Resistance vs. Temperature (Dual Supply)



On-Resistance vs. Temperature (Single Supply)



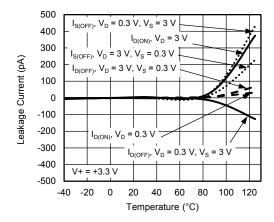
On-Resistance vs. Temperature (Single Supply)



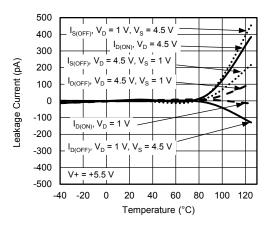
Charge Injection vs. Analog Voltage



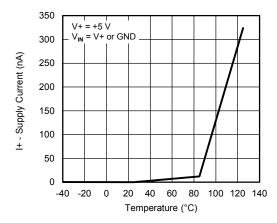
# TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



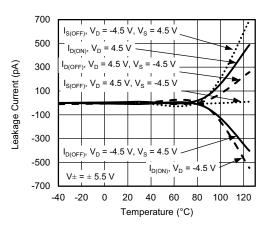
Leakage Current vs. Temperature



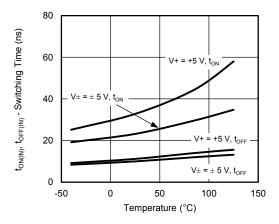
Leakage Current vs. Temperature



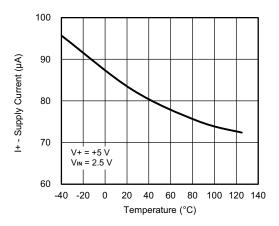
Supply Current vs. Temperature



Leakage Current vs. Temperature



Switching Time vs. Temperature

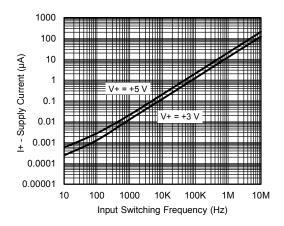


**Supply Current vs. Temperature** 

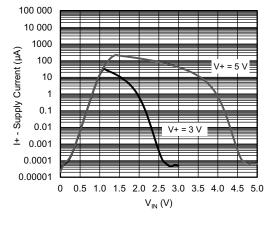
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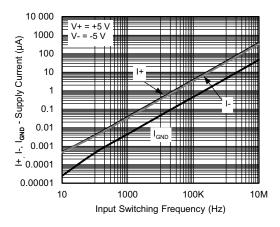
# TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



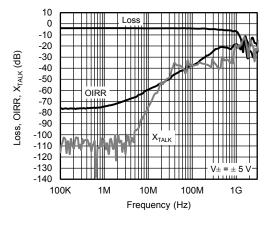
Supply Current vs. Switching Frequency



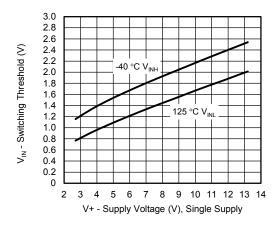
Supply Current vs. Input Voltage



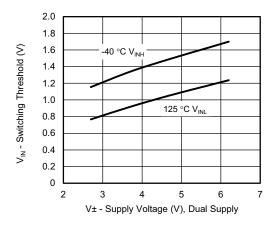
Supply Current vs. Switching Frequency



Insertion Loss, Off-Isolation, Crosstalk vs. Frequency

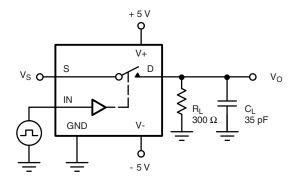


Switching Threshold vs. Supply Voltage (Single Supply)



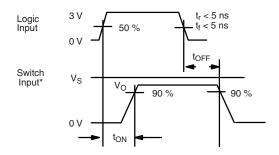
Switching Threshold vs. Supply Voltage (Dual Supply)

#### **TEST CIRCUITS**



 $C_{L}$  (includes fixture and stray capacitance)

$$V_O = V_S$$
 
$$\frac{R_L}{R_L + r_{DS(on)}}$$



Note: Logic input waveform is inverted for switches that have the opposite logic sense control

Fig. 1 - Switching Time

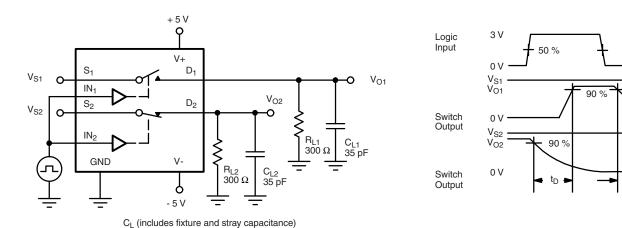
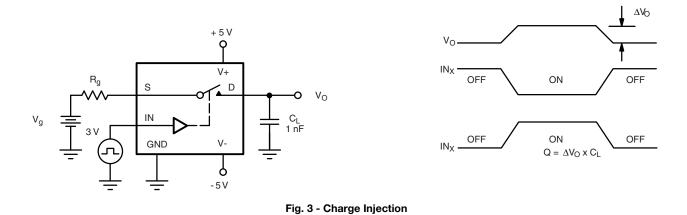


Fig. 2 - Break-Before-Make (DG613E)



#### **TEST CIRCUITS**

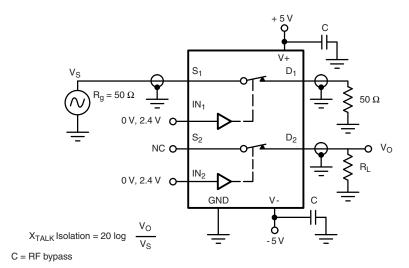


Fig. 4 - Crosstalk

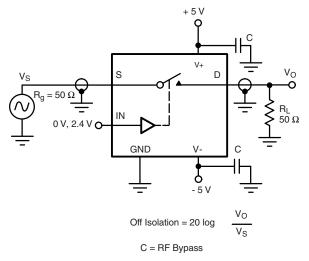


Fig. 5 - Off-Isolation

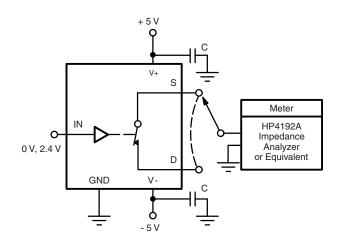
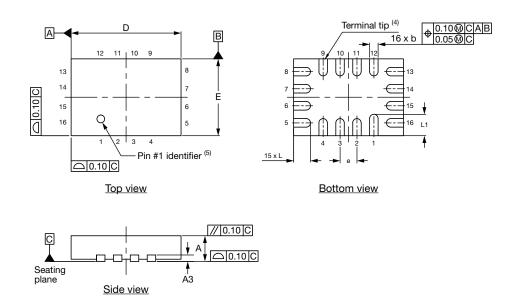


Fig. 6 - Source / Drain Capacitances

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg278910">www.vishay.com/ppg278910</a>.

# Thin miniQFN16 Case Outline



DIMENSIONS		MILLIMETERS (1)			INCHES		
DIMENSIONS	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.50	0.55	0.60	0.020	0.022	0.024	
A1	0	-	0.05	0	-	0.002	
A3		0.15 ref.			0.006 ref.		
b	0.15	0.20	0.25	0.006	0.008	0.010	
D	2.50	2.60	2.70	0.098	0.102	0.106	
е		0.40 BSC			0.016 BSC		
E	1.70	1.80	1.90	0.067	0.071	0.075	
L	0.35	0.40	0.45	0.014	0.016	0.018	
L1	0.45	0.50	0.55	0.018	0.020	0.022	
N <sup>(3)</sup>	16				16		
Nd <sup>(3)</sup>		4			4		
Ne <sup>(3)</sup>		4 4			4		

#### **Notes**

- (1) Use millimeters as the primary measurement.
- (2) Dimensioning and tolerances conform to ASME Y14.5M. 1994.
- (3) N is the number of terminals. Nd and Ne is the number of terminals in each D and E site respectively.
- (4) Dimensions b applies to plated terminal and is measured between 0.15 mm and 0.30 mm from terminal tip.
- (5) The pin 1 identifier must be existed on the top surface of the package by using identification mark or other feature of package body.
- (6) Package warpage max. 0.05 mm.

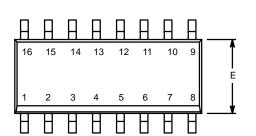
ECN: T16-0226-Rev. B, 09-May-16

DWG: 6023

Revision: 09-May-16 1 Document Number: 64694



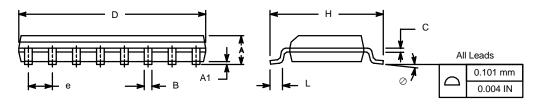
SOIC (NARROW): 16-LEAD
JEDEC Part Number: MS-012



	MILLIMETERS		INC	HES			
Dim	Min	Max	Min	Max			
Α	1.35	1.75	0.053	0.069			
A <sub>1</sub>	0.10	0.20	0.004	0.008			
В	0.38	0.51	0.015	0.020			
С	0.18	0.23	0.007	0.009			
D	9.80	10.00	0.385	0.393			
E	3.80	4.00	0.149	0.157			
е	1.27	BSC	0.050	BSC			
Н	5.80	6.20	0.228	0.244			
L	0.50	0.93	0.020	0.037			
0	0°	8°	0°	8°			
FCN: S-0	FCN: S-03946—Rev. F. 09-Jul-01						

ECN: S-03946—Rev. F, 09-Jul-01

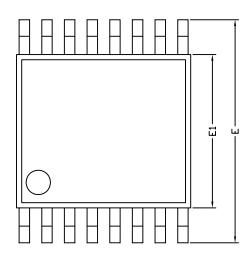
DWG: 5300

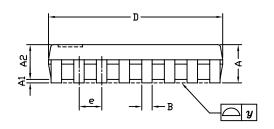


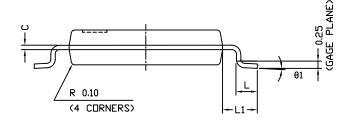
Document Number: 71194 www.vishay.com 02-Jul-01 sww.vishay.com



**TSSOP: 16-LEAD** 







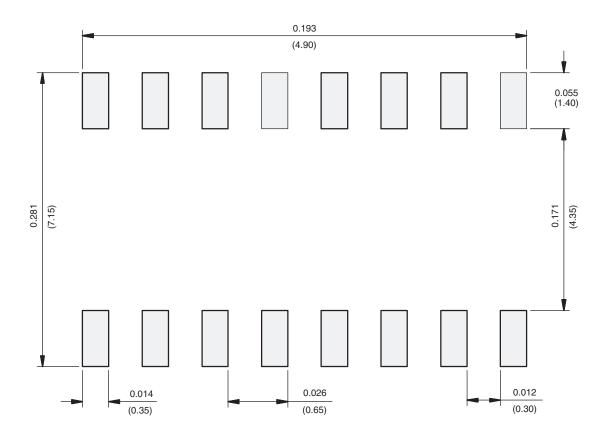
	DI	MENSIONS IN MILLIMETE	RS
Symbols	Min	Nom	Max
Α	-	1.10	1.20
A1	0.05	0.10	0.15
A2	=	1.00	1.05
В	0.22	0.28	0.38
С	=	0.127	-
D	4.90	5.00	5.10
E	6.10	6.40	6.70
E1	4.30	4.40	4.50
е	-	0.65	-
L	0.50	0.60	0.70
L1	0.90	1.00	1.10
у	=	-	0.10
θ1	0°	3°	6°
ECN: S-61920-Rev. D. 23-0	Oct-06		

DWG: 5624

Document Number: 74417 www.vishay.com 23-Oct-06



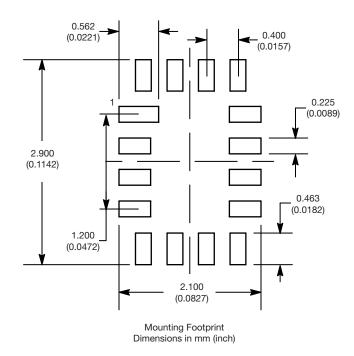
## **RECOMMENDED MINIMUM PAD FOR TSSOP-16**



Recommended Minimum Pads Dimensions in inches (mm)



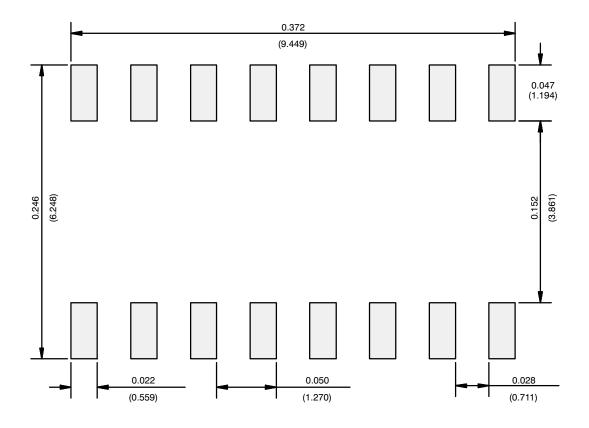
## **RECOMMENDED MINIMUM PADS FOR MINI QFN 16L**



Revision: 05-Mar-10



## **RECOMMENDED MINIMUM PADS FOR SO-16**



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index

APPLICATION NOTE

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